700MHz,

DIFFERENTIAL-TO-3.3V LVPECL FREQUENCY SYNTHESIZER

GENERAL DESCRIPTION



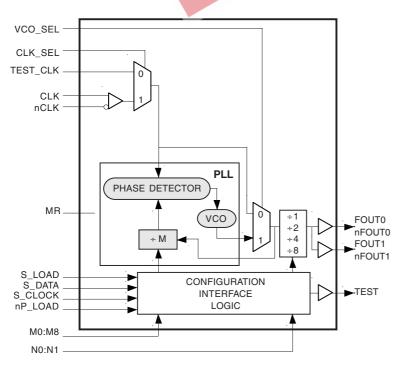
The ICS8432I-101 is a general purpose, dual output Differential-to-3.3V LVPECL high frequency synthesizer and a member of the HiPerClockS[™] family of High Performance Clock Solutions from ICS. The ICS8432I-101 has a selectable

TEST_CLK or CLK, nCLK inputs. The TEST_CLK input accepts LVCMOS or LVTTL input levels and translates them to 3.3V LVPECL levels. The CLK, nCLK pair can accept most standard differential input levels. The VCO operates at a frequency range of 250MHz to 700MHz. The VCO frequency is programmed in steps equal to the value of the input differential or single ended reference frequency. The VCO and output frequency can be programmed using the serial or parallel interfaces to the configuration logic. The low phase noise characteristics of the ICS8432I-101 makes it an ideal clock source for Gigabit Ethernet and SONET applications.

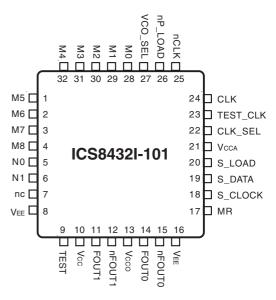
FEATURES

- Dual differential 3.3V LVPECL outputs
- Selectable CLK, nCLK or LVCMOS/LVTTLTEST CLK
- TEST_CLK can accept the following input levels: LVCMOS or LVTTL
- CLK, nCLK pair can accept the following differential input levels: LVPECL, LVDS, LVHSTL, SSTL, HCSL
- CLK, nCLK or TEST_CLK maximum input frequency: 40MHz
- Output frequency range: 25MHz to 700MHz
- VCO range: 250MHz to 700MHz
- Accepts any single-ended input signal on CLK input with resistor bias on nCLK input
- Parallel interface for programming counter and output dividers
- RMS period jitter: 5ps (maximum)
- Cycle-to-cycle jitter: 25ps (maximum)
- 3.3V supply voltage
- -40°C to 85°C ambient operating temperature
- Lead-Free package fully RoHS compliant

BLOCK DIAGRAM



PIN ASSIGNMENT



32-Lead LQFP7mm x 7mm x 1.4mm package body **Y Package**Top View

www.icst.com/products/hiperclocks.html

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FUNCTIONAL DESCRIPTION

NOTE: The functional description that follows describes operation using a 25MHz clock input. Valid PLL loop divider values for different input frequencies are defined in the Input Frequency Characteristics, Table 5, NOTE 1.

The ICS8432I-101 features a fully integrated PLL and therefore requires no external components for setting the loop bandwidth. A differential clock input is used as the input to the ICS8432-101. This input is fed into the phase detector. A 25MHz clock input provides a 25MHz phase detector reference frequency. The VCO of the PLL operates over a range of 250MHz to 700MHz. The output of the M divider is also applied to the phase detector.

The phase detector and the M divider force the VCO output frequency to be M times the reference frequency by adjusting the VCO control voltage. Note, that for some values of M (either too high or too low), the PLL will not achieve lock. The output of the VCO is scaled by a divider prior to being sent to each of the LVPECL output buffers. The divider provides a 50% output duty cycle.

The programmable features of the ICS8432I-101 support two input modes to program the PLL M divider and N output divider. The two input operational modes are parallel and serial. *Figure1* shows the timing diagram for each mode. In parallel mode, the nP_LOAD input is initially LOW. The data on inputs M0 through M8 and N0 and N1 is passed directly to the M divider and N output divider. On the LOW-to-HIGH transition of the nP_LOAD input, the data is latched and the M divider remains loaded until the next LOW transition on nP_LOAD or until a se-

rial event occurs. As a result, the M and N bits can be hardwired to set the M divider and N output divider to a specific default state that will automatically occur during power-up. The TEST output is LOW when operating in the parallel input mode. The relationship between the VCO frequency, the input frequency and the M divider is defined as follows: fVCO = f_{IN} x M

The M value and the required values of M0 through M8 are shown in Table 3B, Programmable VCO Frequency Function Table. Valid M values for which the PLL will achieve lock for a 25MHz reference are defined as $8 \le M \le 28$. The frequency out is defined as follows: $fOUT = \frac{fVCO}{IN} = f_{IN} \times \frac{M}{IN}$

Serial operation occurs when nP_LOAD is HIGH and S_LOAD is LOW. The shift register is loaded by sampling the S_DATA bits with the rising edge of S_CLOCK. The contents of the shift register are loaded into the M divider and N output divider when S_LOAD transitions from LOW-to-HIGH. The M divide and N output divide values are latched on the HIGH-to-LOW transition of S_LOAD. If S_LOAD is held HIGH, data at the S_DATA input is passed directly to the M divider and N output divider on each rising edge of S_CLOCK. The serial mode can be used to program the M and N bits and test bits T1 and T0. The internal registers T0 and T1 determine the state of the TEST output as follows:

<u>T1</u>	<u>T0</u>	TEST Output
0	0	LOW
0	1	S_Data, Shift Register Input
1	0	Output of M divider
1	1	CMOS Fout

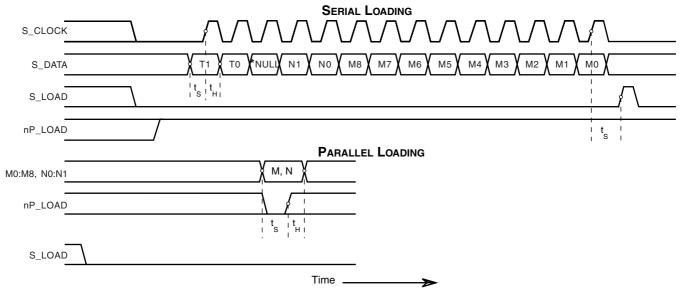


FIGURE 1. PARALLEL & SERIAL LOAD OPERATIONS

*NOTE: The NULL timing slot must be observed.

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TABLE 1. PIN DESCRIPTIONS

Number	Name	Т	/pe	Description
1 2, 3, 4 28, 29 30, 31, 32	M5 M6, M7, M8, M0, M1, M2, M3, M4	Input	Pullup	M divider inputs. Data latched on LOW-to-HIGH transistion of nP_LOAD input. LVCMOS / LVTTL interface levels.
5, 6	N0, N1	Input	Pulldown	Determines output divider value as defined in Table 3C, Function Table. LVCMOS / LVTTL interface levels.
7	nc	Unused		No connect.
8, 16	$V_{\sf EE}$	Power		Negative supply pins.
9	TEST	Output		Test output which is ACTIVE in the serial mode of operation. Output driven LOW in parallel mode. LVCMOS / LVTTL interface levels.
10	V _{cc}	Power		Core supply pin.
11, 12	FOUT1, nFOUT1	Output		Differential output for the synthesizer. 3.3V LVPECL interface levels.
13	V _{cco}	Power		Output supply pin.
14, 15	FOUT0, nFOUT0	Output		Differential output for the synthesizer. 3.3V LVPECL interface levels.
17	MR	Input	Pulldown	Active High Master Reset. When logic HIGH, the internal dividers are reset causing the true outputs FOUTx to go low and the inverted outputs nFOUTx to go high. When logic LOW, the internal dividers and the outputs are enabled. Assertion of MR does not affect loaded M, N, and T values. LVCMOS / LVTTL interface levels.
18	S_CLOCK	Input	Pulldown	Clocks in serial data present at S_DATA input into the shift register on the rising edge of S_CLOCK. LVCMOS / LVTTL interface levels.
19	S_DATA	Input	Pulldown	Shift register serial input. Data sampled on the rising edge of S_CLOCK. LVCMOS / LVTTL interface levels.
20	S_LOAD	Input	Pulldown	Controls transition of data from shift register into the dividers. LVCMOS / LVTTL interface levels.
21	V_{CCA}	Power		Analog supply pin.
22	CLK_SEL	Input	Pullup	Clock select input. Selects between differential clock input or TEST_CLK input as the PLL reference source. When HIGH, selects CLK, nCLK inputs. When LOW, selects TEST_CLK input. LVCMOS / LVTTL interface levels.
23	TEST_CLK	Input	Pulldown	Test clock input. LVCMOS / LVTTL interface levels.
24	CLK	Input	Pulldown	Non-inverting differential clock input.
25	nCLK	Input	Pullup	Inverting differential clock input.
26	nP_LOAD	Input	Pulldown	Parallel load input. Determines when data present at M8:M0 is loaded into M divider, and when data present at N1:N0 sets the N output divider value. LVCMOS / LVTTL interface levels.
27	VCO_SEL	Input	Pullup	Determines whether synthesizer is in PLL or bypass mode. LVCMOS / LVTTL interface levels.

NOTE: Pullup and Pulldown refer to internal input resistors. See Table 2, Pin Characterisitics, for typical values.

TABLE 2. PIN CHARACTERISTICS

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
C _{IN}	Input Capacitance			4		pF
R _{PULLUP}	Input Pullup Resistor			51		kΩ
R _{PULLDOWN}	Input Pulldown Resistor			51		kΩ

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TABLE 3A. PARALLEL AND SERIAL MODE FUNCTION TABLE

			In	puts			Conditions				
MR	nP_LOAD	М	N	S_LOAD	S_CLOCK	S_DATA	Conditions				
Н	Х	Х	Х	Х	Х	Х	Reset. Forces outputs LOW.				
L	L	Data	Data	Х	Х	Х	Data on M and N inputs passed directly to the M divider and N output divider. TEST output forced LOW.				
L	1	Data	Data	L	Х	Х	Data is latched into input registers and remains loaded until next LOW transition or until a serial event occurs.				
L	Н	Х	Х	L	1	Data	Serial input mode. Shift register is loaded with data on S_DATA on each rising edge of S_CLOCK.				
L	Н	Х	Х	1	L	Data	Contents of the shift register are passed to the M divider and N output divider.				
L	Н	Χ	Х	\rightarrow	L	Data	M divider and N output divider values are latched.				
L	Н	Χ	Х	L	Х	Х	Parallel or serial inputs do not affect shift registers.				
L	Н	Х	Х	Н	1	Data	S_DATA passed directly to M divider as it is clocked.				
NOT	L H X X H ↑ Data S_DATA passed directly to M divider as it is clocked. NOTE: L = LOW H = HIGH X = Don't care ↑ = Rising edge transition ↓ = Falling edge transition										

TABLE 3B. PROGRAMMABLE VCO FREQUENCY FUNCTION TABLE

VCO Frequency	M Divide	256	128	64	32	16	8	4	2	1
(MHz)	IVI DIVIGE	M8	M7	М6	M5	M4	М3	M2	M1	МО
250	10	0	0	0	0	0	1	0	1	0
275	11	0	0	0	0	0	1	0	1	1
•	•	•	•	•	•	•	•	•	•	•
•	•	•	•	•	•	•	•	•	•	•
650	26	0	0	0	0	1	1	0	1	0
675	27	0	0	0	0	1	1	0	1	1
700	28	0	0	0	0	1	1	1	0	0

NOTE 1: These M divide values and the resulting frequencies correspond to differential input or TEST_CLK input frequency of 25MHz.

TABLE 3C. PROGRAMMABLE OUTPUT DIVIDER FUNCTION TABLE

Inp	outs	N Divider Value	Output Frequency (MHz)		
N1	N0	N Divider value	Minimum	Maximum	
0	0	1	250	700	
0	1	2	125	350	
1	0	4	62.5	175	
1	1	8	31.25	87.5	



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ABSOLUTE MAXIMUM RATINGS

4.6V Supply Voltage, V_{CC}

-0.5V to $V_{CC} + 0.5V$ Inputs, V₁

Outputs, I_o Continuous Current 50mA Surge Current 100mA

Package Thermal Impedance, θ_{IA} 47.9°C/W (0 lfpm) -65°C to 150°C Storage Temperature, T_{STG}

NOTE: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These ratings are stress specifications only. Functional operation of product at these conditions or any conditions beyond those listed in the DC Characteristics or AC Characteristics is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

Table 4A. Power Supply DC Characteristics, $V_{CC} = V_{CCA} = V_{CCO} = 3.3V \pm 5\%$, Ta = -40°C to 85°C

Symbol	Parameter	Test (Conditio	ns	Minimum	Typical	Maximum	Units
V _{cc}	Core Supply Voltage				3.135	3.3	3.465	V
V _{CCA}	Analog Supply Voltage			47	3.135	3.3	3.465	٧
V _{cco}	Output Supply Voltage			132	3.135	3.3	3.465	V
I _{EE}	Power Supply Current			CO.			120	mA
I _{CCA}	Analog Supply Current			1			15	mA

TABLE 4B. LVCMOS / LVTTL DC CHARACTERISTICS, $V_{CC} = V_{CCA} = V_{CCO} = 3.3V \pm 5\%,$ Ta = -40°C to 85°C

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
V _{IH}	Input High Voltage	VCO_SEL, CLK_SEL, MR, S_LOAD, S_DATA, S_CLOCK, nP_LOAD, M0:M8, N0:N1		2		V _{cc} + 0.3	V
		TEST_CLK		2			V
V _{IL}	Input Low Voltage	VCO_SEL, CLK_SEL, MR, S_LOAD, S_DATA, S_CLOCK, nP_LOAD, M0:M8, N0:N1		-0.3		0.8	V
		TEST_CLK		-0.3		1.3	V
I _{IH}	Input High Current	M0-M4, M6-M8, N0, N1, MR, S_CLOCK, TEST_CLK, S_DATA, S_LOAD, nP_LOAD	$V_{CC} = V_{IN} = 3.465V$			150	μΑ
		M5, CLK_SEL, VCO_SEL	$V_{CC} = V_{IN} = 3.465V$			5	μΑ
I	Input	M0-M4, M6-M8, N0, N1, MR, S_CLOCK, TEST_CLK, S_DATA, S_LOAD, nP_LOAD	$V_{CC} = 3.465V,$ $V_{IN} = 0V$	-5			μΑ
-1L	Low Current	M5, CLK_SEL, VCO_SEL	$V_{CC} = 3.465V,$ $V_{IN} = 0V$	-150		V _{cc} + 0.3 V _{cc} + 0.3 0.8 1.3 150 5	μΑ
V _{OH}	Output High Voltage	TEST	$V_{CC} = 3.135V,$ $I_{OH} = -36mA$	2.6			V
V _{OL}	Output Low Voltage	TEST	$V_{CC} = 3.135V,$ $I_{OL} = 36mA$			0.5	V



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Table 4C. Differential DC Characteristics, $V_{CC} = V_{CCA} = V_{CCC} = 3.3V \pm 5\%$, Ta = -40°C to 85°C

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
I _{IH} Inp	Input High Current	CLK	$V_{CC} = V_{IN} = 3.465V$			150	μΑ
		nCLK	$V_{CC} = V_{IN} = 3.465V$			5	μΑ
1	Input Low Current	CLK	$V_{CC} = 3.465V, V_{IN} = 0V$	-5			μΑ
IIL	Input Low Current	nCLK	$V_{CC} = 3.465V, V_{IN} = 0V$	-150			μΑ
V _{PP}	Peak-to-Peak Input Voltage			0.15		1.3	V
V _{CMR}	Common Mode Inp	ut Voltage		V _{EE} + 0.5		V _{cc} - 0.85	V

NOTE 1: For single ended applications, the maximum input voltage for CLK, nCLK is V_{cc} + 0.3V.

NOTE 2: Common mode voltage is defined as $V_{\mbox{\tiny IH}}$.

Table 4D. LVPECL DC Characteristics, $V_{CC} = V_{CCA} = V_{CCO} = 3.3V \pm 5\%$, Ta = -40°C to 85°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V _{OH}	Output High Voltage; NOTE 1		V _{cco} - 1.4		V _{cco} - 0.9	V
V _{OL}	Output Low Voltage; NOTE 1	4	V _{cco} - 2.0		V _{cco} - 1.7	٧
V _{SWING}	Peak-to-Peak Output Voltage Swing	3. 3	0.6		1.0	V

NOTE 1: Outputs terminated with 50 Ω to $V_{\rm cco}$ - 2V.

Table 5. Input Frequency Characteristics, $V_{CC} = V_{CCA} = V_{CCC} = 3.3V \pm 5\%$, Ta = -40°C to 85°C

Symbol	Parameter			Test Conditions	Minimum	Typical	Maximum	Units
f _{IN}	Input Frequency	TEST_CLK; NOTE 1	1		14		25	MHz
		CLK, nCLK; NOTE 1	ζ.		14		25	MHz
		S_CLOCK					25	MHz

NOTE 1: For the differential input and TEST_CLK frequency range, the M value must be set for the VCO to operate within the 250MHz to 700MHz range. Using the minimum input frequency of 14MHz, valid values of M are $18 \le M \le 50$. Using the maximum frequency of 25MHz, valid values of M are $10 \le M \le 28$.

Table 6. AC Characteristics, $V_{CC} = V_{CCA} = V_{CCO} = 3.3V \pm 5\%$, Ta = -40°C to 85°C

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
F _{out}	Output Frequ	uency		31.25		700	MHz
tjit(cc)	Cycle-to-Cyc	cle Jitter; NOTE 1, 3	fVCO > 350MHz			25	ps
tjit(per)	Period Jitter, RMS; NOTE 1		fOUT > 100MHz			5	ps
tsk(o)	Output Skew; NOTE 2, 3					15	ps
t _R / t _F	Output Rise/Fall Time		20% to 80%	200		700	ps
		M, N to nP_LOAD		5			ns
t _s	Setup Time	S_DATA to S_CLOCK		5			ns
		S_CLOCK to S_LOAD		5			ns
		M, N to nP_LOAD		5			ns
t _H	Hold Time	S_DATA to S_CLOCK		5			ns
		S_CLOCK to S_LOAD		5	25 ps 5 ps 15 ps 1700 ps 700 ps 18 ns 18 ns 18 ns 18 ns 18 ns 18 ps 18 ps	ns	
odc	Output Duty Cycle		N > 1	47		53	%
t _{PW}	Output Pulse Width		N = 1	t _{PERIOD} /2 - 150		$t_{PERIOD}/2 + 150$	ps
t _{LOCK}	PLL Lock Tir	ne				1	ms

See Parameter Measurement Information section.

NOTE 1: Jitter performance using XTAL inputs.

NOTE 2: Defined as skew between outputs at the same supply voltage and with equal load conditions.

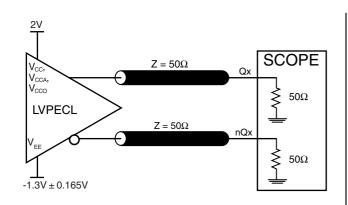
Measured at the output differential cross points.

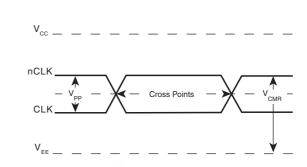
NOTE 3: This parameter is defined in accordance with JEDEC Standard 65.

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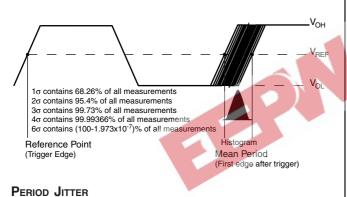
PARAMETER MEASUREMENT INFORMATION

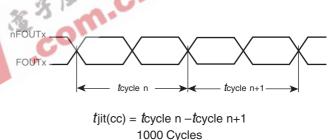




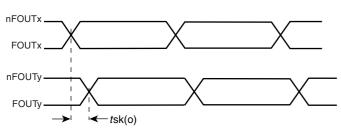
3.3V OUTPUT LOAD AC TEST CIRCUIT

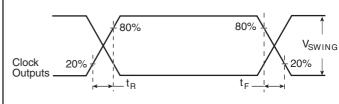






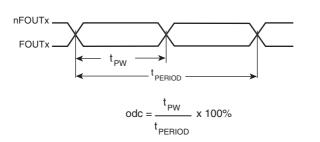
CYCLE-TO-CYCLE JITTER





OUTPUT SKEW

OUTPUT RISE/FALL TIME



OUTPUT DUTY CYCLE/PULSE WIDTH/PERIOD

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APPLICATION INFORMATION

STORAGE AREA NETWORKS

A variety of technologies are used for interconnection of the elements within a SAN. The tables below list the common appli-

cation frequencies as well as the ICS8432I-101 configurations used to generate the appropriate frequency.

Table 7. Common SANs Application Frequencies

Interconnect Technology	Clock Rate	Reference Frequency to SERDES (MHz)	Crystal Frequency (MHz)
Gigabit Ethernet	1.25 GHz	125, 250, 156.25	25, 19.53125
Fibre Channel	FC1 1.0625 GHz FC2 2.1250 GHz	106.25, 53.125, 132.8125	16.6015625, 25
Infiniband	2.5 GHz	125, 250	25

Table 8. Configuration Details for SANs Applications

Interconnect	CLK, nCLK Input	ICS8432I-101 Output Frequency	ICS8432I-101 M & N Settings										
Technology	(MHz)	to SERDES (MHz)	М8	М7	М6	M5	М4	МЗ	M2	M1	МО	N1	N0
Gigabit Ethernet	25	125	0	0	0	0	1	0	1	0	0	1	0
	25	250	0	0	0	0	1	0	1	0	0	0	1
	25	156.25	0	0	0	0	1	1	0	0	1	1	0
	19.53125	156.25	0	0	0	1	0	0	0	0	0	1	0
Fiber Channel 1	25	53.125	0	0	0	0	1	0	0	0	1	1	1
Fiber Channel 1	25	106.25	0	0	0	0	1	0	0	0	1	1	0
Fiber Channel 2	16.6015625	132.8125	0	0	0	1	0	0	0	0	0	1	0
Infiniband	25	125	0	0	0	0	1	0	1	0	0	1	0
	25	250	0	0	0	0	1	0	1	0	0	0	1

Power Supply Filtering Techniques

As in any high speed analog circuitry, the power supply pins are vulnerable to random noise. The ICS8432I-101 provides separate power supplies to isolate any high switching noise from the outputs to the internal PLL. $V_{\rm CC}, V_{\rm CCA},$ and $V_{\rm CCO}$ should be individually connected to the power supply plane through vias, and bypass capacitors should be used for each pin. To achieve optimum jitter performance, power supply isolation is required. Figure 2 illustrates how a 10Ω resistor along with a $10\mu F$ and a $.01\mu F$ bypass capacitor should be connected to each $V_{\rm CCA}$ pin.

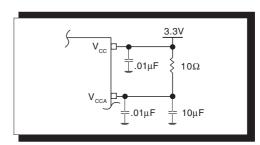


FIGURE 2. POWER SUPPLY FILTERING

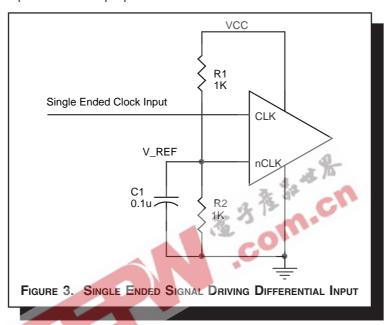
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WIRING THE DIFFERENTIAL INPUT TO ACCEPT SINGLE ENDED LEVELS

Figure 3 shows how the differential input can be wired to accept single ended levels. The reference voltage $V_REF = V_{cc}/2$ is generated by the bias resistors R1, R2 and C1. This bias circuit should be located as close as possible to the input pin. The ratio

of R1 and R2 might need to be adjusted to position the V_REF in the center of the input voltage swing. For example, if the input clock swing is only 2.5V and $V_{cc} = 3.3V$, $V_{cc} = 1.25V$ and R2/R1 = 0.609.



TERMINATION FOR LVPECL OUTPUTS

The clock layout topology shown below is a typical termination for LVPECL outputs. The two different layouts mentioned are recommended only as guidelines.

FOUT and nFOUT are low impedance follower outputs that generate ECL/LVPECL compatible outputs. Therefore, terminating resistors (DC current path to ground) or current sources must be used for functionality. These outputs are

designed to drive 50Ω transmission lines. Matched impedance techniques should be used to maximize operating frequency and minimize signal distortion. Figures 4A and 4B show two different layouts which are recommended only as guidelines. Other suitable clock layouts may exist and it would be recommended that the board designers simulate to guarantee compatibility across all printed circuit and clock component process variations.

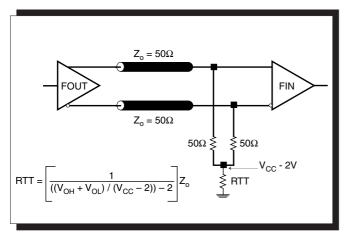


FIGURE 4A. LVPECL OUTPUT TERMINATION

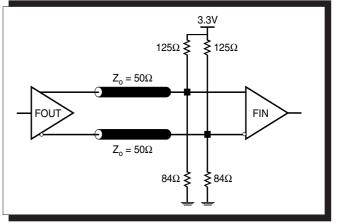


FIGURE 4B. LVPECL OUTPUT TERMINATION

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DIFFERENTIAL CLOCK INPUT INTERFACE

The CLK /nCLK accepts LVDS, LVPECL, LVHSTL, SSTL, HCSL and other differential signals. Both V_{SWING} and V_{OH} must meet the V_{PP} and V_{CMR} input requirements. Figures 5A to 5D show interface examples for the HiPerClockS CLK/nCLK input driven by the most common driver types. The input interfaces suggested

here are examples only. Please consult with the vendor of the driver component to confirm the driver termination requirements. For example in *Figure 5A*, the input termination applies for ICS HiPerClockS LVHSTL drivers. If you are using an LVHSTL driver from another vendor, use their termination recommendation.

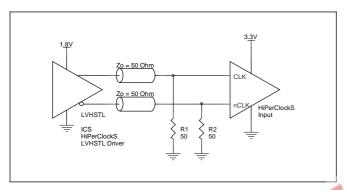


FIGURE 5A. HIPERCLOCKS CLK/NCLK INPUT DRIVEN BY ICS HIPERCLOCKS LVHSTL DRIVER

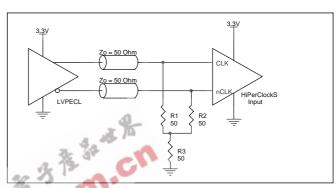


FIGURE 5B. HIPERCLOCKS CLK/NCLK INPUT DRIVEN BY 3.3V LVPECL DRIVER

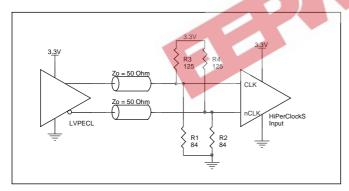


FIGURE 5C. HIPERCLOCKS CLK/NCLK INPUT DRIVEN BY 3.3V LVPECL DRIVER

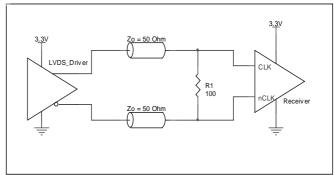


FIGURE 5D. HIPERCLOCKS CLK/NCLK INPUT DRIVEN BY 3.3V LVDS DRIVER

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LAYOUT GUIDELINE

The schematic of the ICS8432I-101 layout example used in this layout guideline is shown in *Figure 6A*. The ICS8432I-101 recommended PCB board layout for this example is shown in *Figure 6B*. This layout example is used as a general guideline.

The layout in the actual system will depend on the selected component types, the density of the components, the density of the traces, and the stack up of the P.C. board.

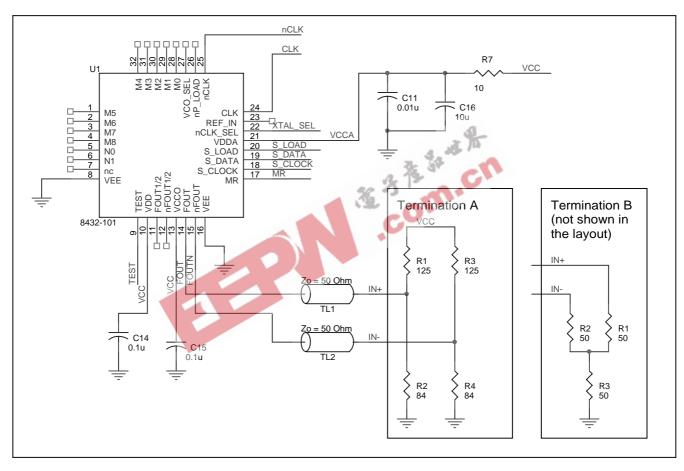


FIGURE 6A. SCHEMATIC OF RECOMMENDED LAYOUT

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The following component footprints are used in this layout example: All the resistors and capacitors are size 0603.

POWER AND GROUNDING

Place the decoupling capacitors C14 and C15 as close as possible to the power pins. If space allows, placing the decoupling capacitor at the component side is preferred. This can reduce unwanted inductance between the decoupling capacitor and the power pin generated by the via.

Maximize the pad size of the power (ground) at the decoupling capacitor. Maximize the number of vias between power (ground) and the pads. This can reduce the inductance between the power (ground) plane and the component power (ground) pins.

If V $_{\rm CCA}$ shares the same power supply with V $_{\rm CC}$, insert the RC filter R7, C11, and C16 in between. Place this RC filter as close to the V $_{\rm CCA}$ as possible.

CLOCK TRACES AND TERMINATION

The component placements, locations and orientations should be arranged to achieve the best clock signal quality. Poor clock signal quality can degrade the system performance or cause system failure. In the synchronous high-speed digital system, the clock signal is less tolerable to poor signal quality than other signals. Any ringing on the rising or falling edge or excessive ring back can cause

system failure. The trace shape and the trace delay might be restricted by the available space on the board and the component location. While routing the traces, the clock signal traces should be routed first and should be locked prior to routing other signal traces.

- The traces with 50Ω transmission lines TL1 and TL2 at FOUT and nFOUT should have equal delay and run adjacent to each other. Avoid sharp angles on the clock trace. Sharp angle turns cause the characteristic impedance to change on the transmission lines.
- Keep the clock trace on same layer. Whenever possible, avoid any vias on the clock traces. Any via on the trace can affect the trace characteristic impedance and hence degrade signal quality.
- To prevent cross talk, avoid routing other signal traces in parallel with the clock traces. If running parallel traces is unavoidable, allow more space between the clock trace and the other signal trace.
- Make sure no other signal trace is routed between the clock trace pair.

The matching termination resistors R1, R2, R3 and R4 should be located as close to the receiver input pins as possible. Other termination schemes can also be used but are not shown in this example.

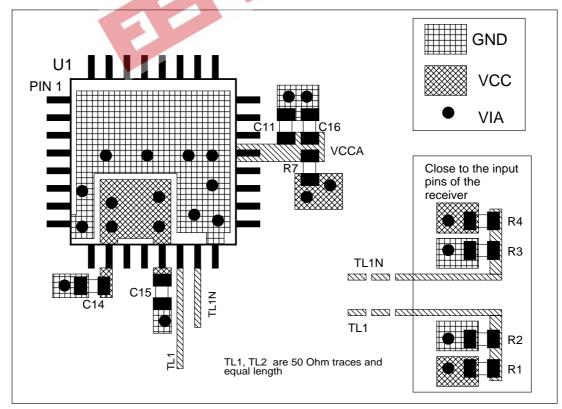


FIGURE 6B. PCB BOARD LAYOUT FOR ICS8432I-101

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Power Considerations

This section provides information on power dissipation and junction temperature for the ICS8432I-101. Equations and example calculations are also provided.

1. Power Dissipation.

The total power dissipation for the ICS8432I-101 is the sum of the core power plus the power dissipated in the load(s). The following is the power dissipation for $V_{CC} = 3.3V + 5\% = 3.465V$, which gives worst case results.

NOTE: Please refer to Section 3 for details on calculating power dissipated in the load.

- Power (core)_{MAX} = V_{CC_MAX} * I_{EE_MAX} = 3.465V * 120mA = 416mW
- Power (outputs)_{MAX} = 30mW/Loaded Output pair
 If all outputs are loaded, the total power is 2 * 30mW = 60mW

Total Power $_{MAX}$ (3.465V, with all outputs switching) = 416mW + 60mW = 476mW

2. Junction Temperature.

Junction temperature, Tj, is the temperature at the junction of the bond wire and bond pad and directly affects the reliability of the device. The maximum recommended junction temperature for HiPerClockS™ devices is 125°C.

The equation for Tj is as follows: Tj = θ_{14} * Pd_total + Tj

Tj = Junction Temperature

 θ_{JA} = Junction-to-Ambient Thermal Resistance

Pd_total = Total Device Power Dissipation (example calculation is in section 1 above)

 $T_A =$ Ambient Temperature

In order to calculate junction temperature, the appropriate junction-to-ambient thermal resistance θ_{JA} must be used. Assuming a moderate air flow of 200 linear feet per minute and a multi-layer board, the appropriate value is 42.1°C/W per Table 9 below.

Therefore, Tj for an ambient temperature of 85°C with all outputs switching is:

 $85^{\circ}\text{C} + 0.476\text{W} * 42.1^{\circ}\text{C/W} = 105^{\circ}\text{C}$. This is well below the limit of 125°C .

This calculation is only an example. Tj will obviously vary depending on the number of loaded outputs, supply voltage, air flow, and the type of board (single layer or multi-layer).

Table 9. Thermal Resistance θ_{JA} for 32-pin LQFP, Forced Convection

$\theta_{_{JA}}$ by Velocity (Linear Feet per Minute)

 0
 200
 500

 Single-Layer PCB, JEDEC Standard Test Boards
 67.8°C/W
 55.9°C/W
 50.1°C/W

 Multi-Layer PCB, JEDEC Standard Test Boards
 47.9°C/W
 42.1°C/W
 39.4°C/W

NOTE: Most modern PCB designs use multi-layered boards. The data in the second row pertains to most designs.

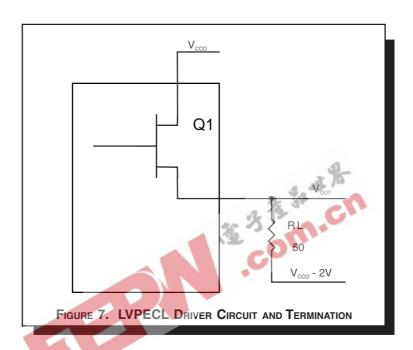
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3. Calculations and Equations.

The purpose of this section is to derive the power dissipated into the load.

LVPECL output driver circuit and termination are shown in Figure 7.



To calculate worst case power dissipation into the load, use the following equations which assume a 50Ω load, and a termination voltage of V_{CCO} - 2V.

• For logic high,
$$V_{OUT} = V_{OH_MAX} = V_{CCO_MAX} - 0.9V$$

$$(V_{CCO_MAX} - V_{OH_MAX}) = 0.9V$$

• For logic low, $V_{OUT} = V_{OL_MAX} = V_{CCO_MAX} - 1.7V$

$$(V_{CCO_MAX} - V_{OL_MAX}) = 1.7V$$

Pd_H is power dissipation when the output drives high.

Pd_L is the power dissipation when the output drives low.

$$Pd_{-}H = [(V_{OH_MAX} - (V_{CCO_MAX} - 2V))/R_{L}] * (V_{CCO_MAX} - V_{OH_MAX}) = [(2V - (V_{CCO_MAX} - V_{OH_MAX}))/R_{L}] * (V_{CCO_MAX} - V_{OH_MAX}) = [(2V - 0.9V)/50\Omega] * 0.9V = 19.8mW$$

$$Pd_L = [(V_{\tiny OL_MAX} - (V_{\tiny CCO_MAX} - 2V))/R_{\tiny L}] * (V_{\tiny CCO_MAX} - V_{\tiny OL_MAX}) = [(2V - (V_{\tiny CCO_MAX} - V_{\tiny OL_MAX}))/R_{\tiny L}] * (V_{\tiny CCO_MAX} - V_{\tiny OL_MAX}) = [(2V - 1.7V)/50\Omega] * 1.7V = 10.2mW$$

Total Power Dissipation per output pair = Pd_H + Pd_L = 30mW

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RELIABILITY INFORMATION

Table 10. θ_{JA} vs. Air Flow Table for 32 Lead LQFP

θ_{μα} by Velocity (Linear Feet per Minute)

 O
 200
 500

 Single-Layer PCB, JEDEC Standard Test Boards
 67.8°C/W
 55.9°C/W
 50.1°C/W

 Multi-Layer PCB, JEDEC Standard Test Boards
 47.9°C/W
 42.1°C/W
 39.4°C/W

NOTE: Most modern PCB designs use multi-layered boards. The data in the second row pertains to most designs.

TRANSISTOR COUNT

The transistor count for ICS8432I-101 is: 3712



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PACKAGE OUTLINE - Y SUFFIX FOR 32 LEAD LQFP

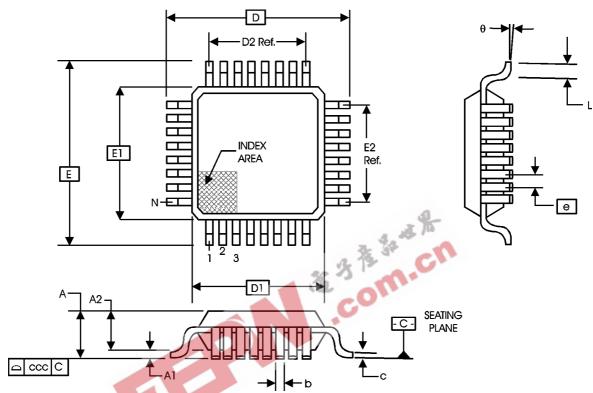


TABLE 11. PACKAGE DIMENSIONS

JEDEC VARIATION ALL DIMENSIONS IN MILLIMETERS							
CVMBOL	ВВА						
SYMBOL	МІМІМИМ	NOMINAL	MAXIMUM				
N		32					
Α			1.60				
A 1	0.05		0.15				
A2	1.35	1.40	1.45				
b	0.30	0.37	0.45				
С	0.09		0.20				
D		9.00 BASIC					
D1		7.00 BASIC					
D2		5.60					
E		9.00 BASIC					
E1		7.00 BASIC					
E2		5.60					
е		0.80 BASIC					
L	0.45	0.60	0.75				
θ	0°		7°				
ccc			0.10				

Reference Document: JEDEC Publication 95, MS-026

8432DYI-101



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TABLE 12. ORDERING INFORMATION

Part/Order Number	Marking	Package	Shipping Packaging	Temperature
ICS8432DYI-101	ICS8432DI-101	32 Lead LQFP	250	-40°C to 85°C
ICS8432DYI-101T	ICS8432DI-101	32 Lead LQFP	1000 tape & reel	-40°C to 85°C
ICS8432DYI-101LF	ICS432DI101L	32 Lead "Lead-Free" LQFP	250	-40°C to 85°C
ICS8432DYI-101LFT	ICS432DI101L	32 Lead "Lead-Free" LQFP	1000 tape & reel	-40°C to 85°C

NOTE: Parts that are ordered with an "LF" suffix to the part number are the Pb-Free configuration and are RoHS compliant.



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	REVISION HISTORY SHEET							
Rev	Rev Table Page Description of Change							
Α	T12	1 17	Features Section - added Lead-Free bullet. Ordering Information Table - add Lead-Free parts.	5/23/05				

